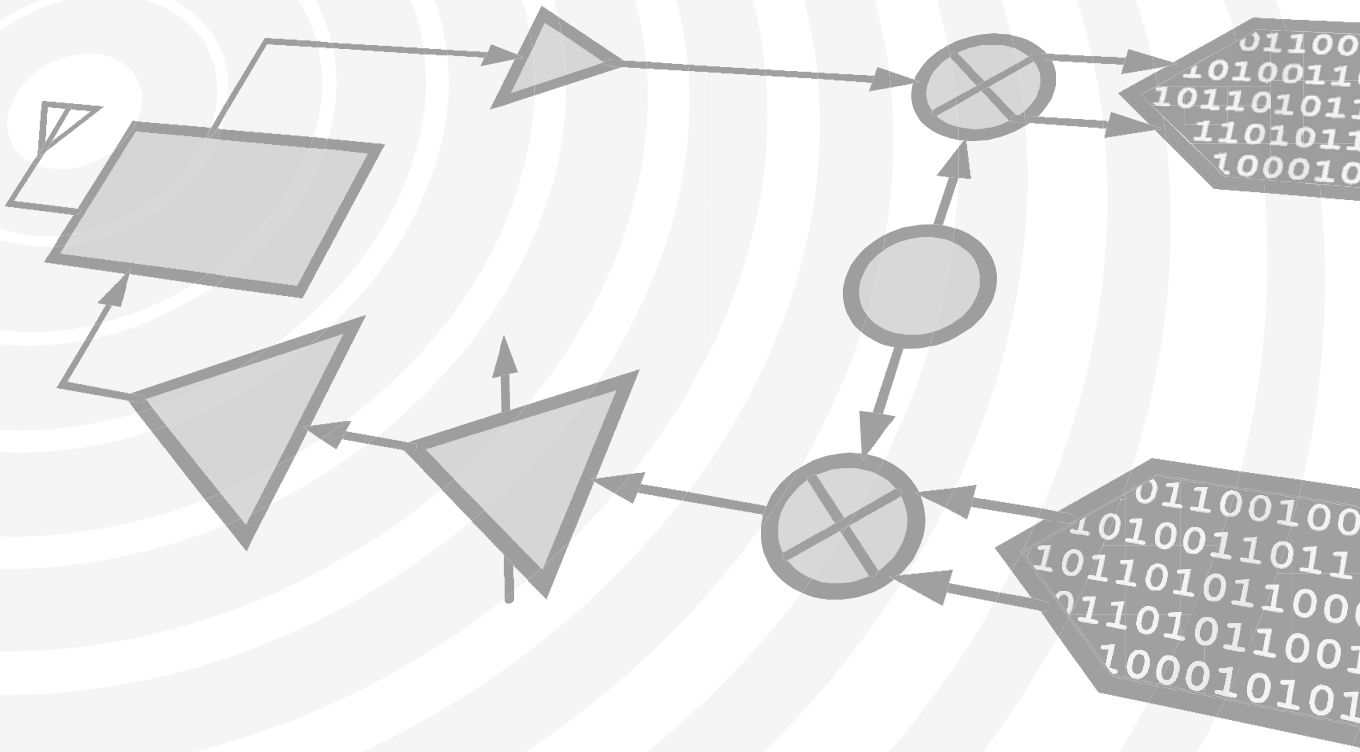
ANALOG DEVICES

Hittite MICROWAVE PRODUCTS FROM ANALOG DEVICES

Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



www.analog.com

www.hittite.com

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HMC514LP5 / 514LP5E

v03.0811

MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.17 - 12.02 GHz

Typical Applications

Low noise MMIC VCO w/Half Frequency, Divide-by-4 Outputs for:

- VSAT Radio
- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- Military End-Use

Features

Dual Output: Fo = 11.17 - 12.02 GHz
Fo/2 = 5.58 - 6.01 GHz

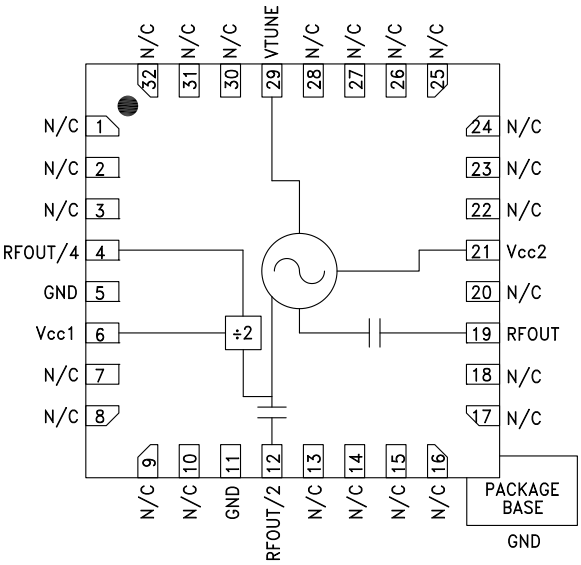
Pout: +7 dBm

Phase Noise: -110 dBc/Hz @100 KHz Typ.

No External Resonator Needed

32 Lead 5x5mm SMT Package: 25mm²

Functional Diagram



General Description

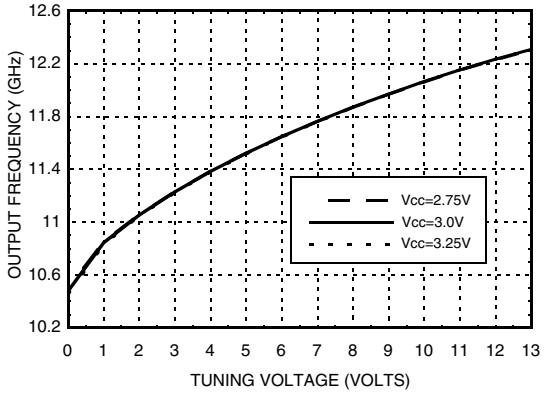
The HMC514LP5 & HMC514LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC514LP5 & HMC514LP5E integrate resonators, negative resistance devices, varactor diodes and feature half frequency and divide-by-4 outputs. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +7 dBm typical from a +3V supply voltage. The prescaler function can be disabled to conserve current if not required. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, T_A = +25° C, Vcc1, Vcc2 = +3V

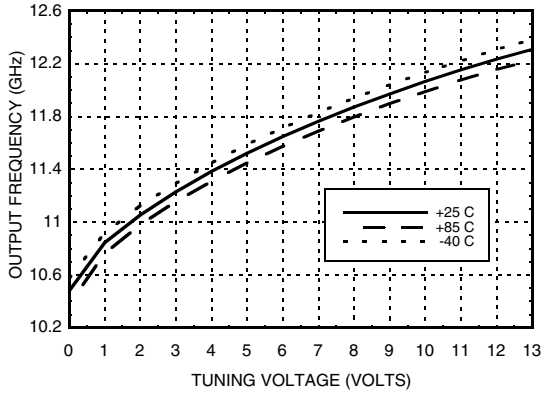
Parameter		Min.	Typ.	Max.	Units
Frequency Range	Fo Fo/2		11.17 - 12.02 5.585 - 6.01		GHz GHz
Power Output	RFOUT RFOUT/2 RFOUT/4	+5 +5 -10		+10 +11 -4	dBm dBm dBm
SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RFOUT			-110		dBc/Hz
Tune Voltage	Vtune	2		13	V
Supply Current	Icc1 & Icc2	240	275	290	mA
Tune Port Leakage Current (Vtune= 13V)				10	µA
Output Return Loss			2		dB
Harmonics/Subharmonics	1/2 3/2 2nd 3rd		30 24 17 28		dBc dBc dBc dBc
Pulling (into a 2.0:1 VSWR)			4		MHz pp
Pushing @ Vtune= 5V			18		MHz/V
Frequency Drift Rate			1.2		MHz/°C

MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.17 - 12.02 GHz

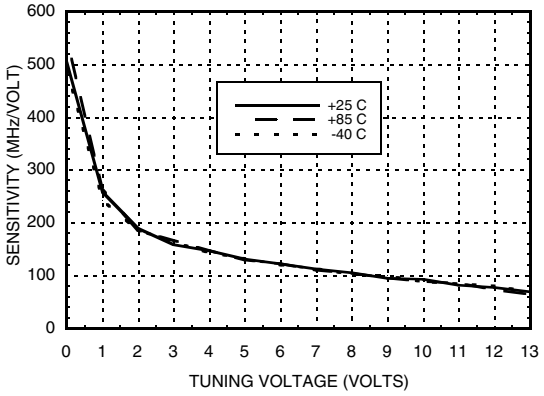
Frequency vs. Tuning Voltage, T= 25°C



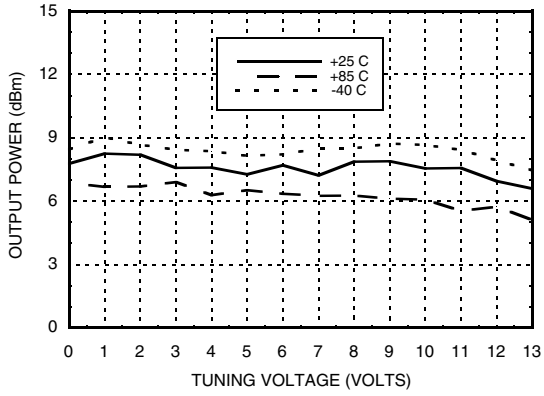
Frequency vs. Tuning Voltage, Vcc= +3V



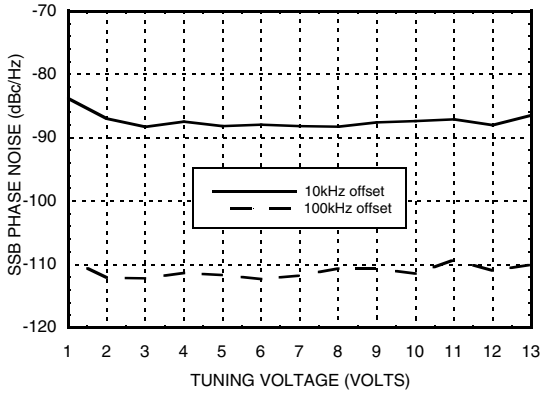
Sensitivity vs. Tuning Voltage, Vcc= +3V



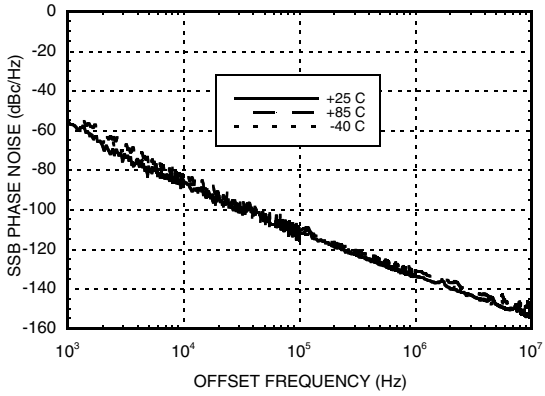
Output Power vs. Tuning Voltage, Vcc= +3V



SSB Phase Noise vs. Tuning Voltage

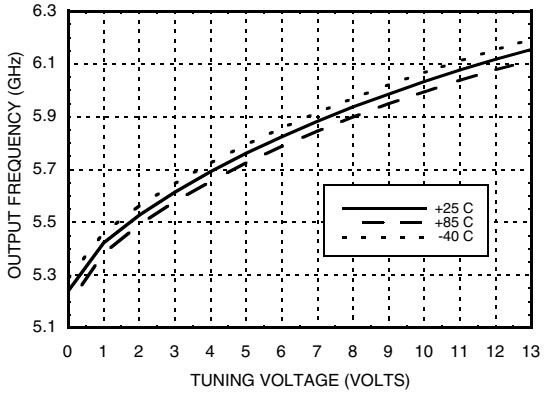


SSB Phase Noise @ Vtune= +5V

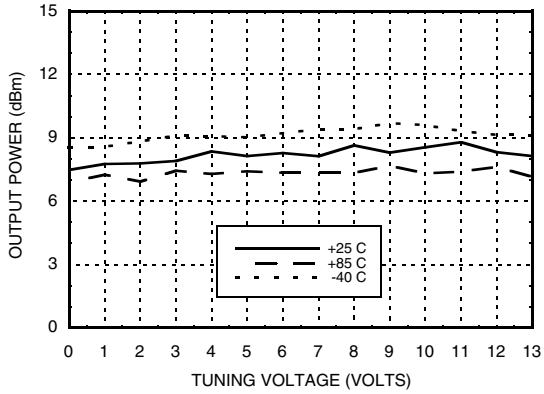


MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.17 - 12.02 GHz

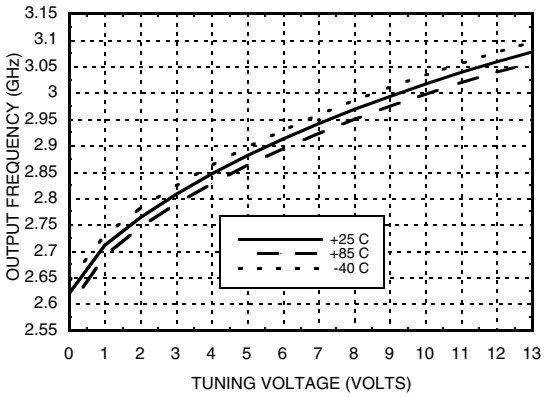
RFOUT/2 Frequency vs. Tuning Voltage, Vcc= +3V



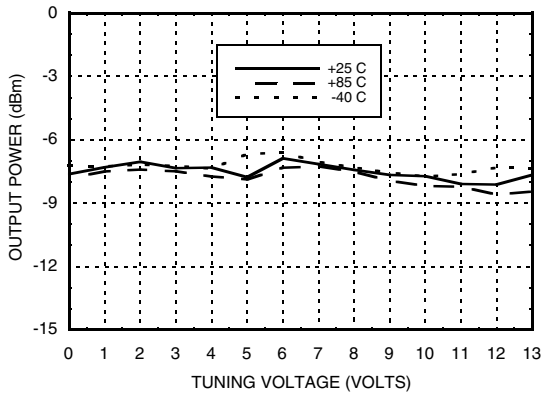
RFOUT/2 Output Power vs. Tuning Voltage, Vcc= +3V



Divide-by-4 Frequency vs. Tuning Voltage, Vcc= +3V



Divide-by-4 Output Power vs. Tuning Voltage, Vcc= +3V



Absolute Maximum Ratings

Vcc1, Vcc2	+3.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 27 mW/C above 85 °C	1.3 W
Thermal Resistance (junction to ground paddle)	37.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vcc

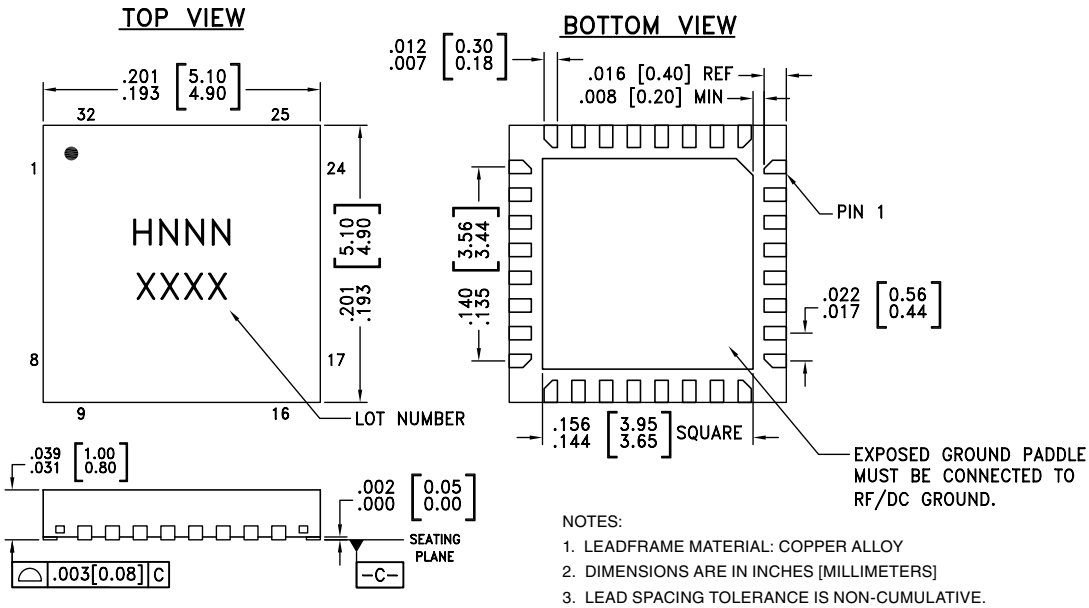
Vcc (V)	Icc (mA)
2.75	230
3.0	275
3.25	320

Note: VCO will operate over full voltage range shown above.

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.17 - 12.02 GHz

Outline Drawing



NOTES:

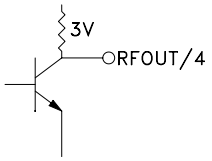
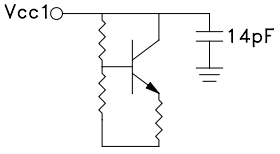
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

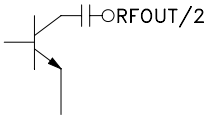
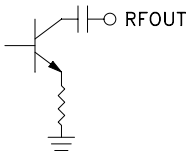
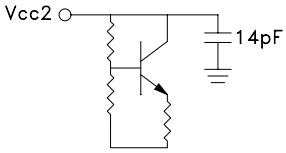
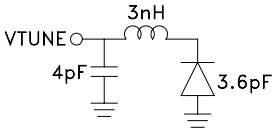
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC514LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL3 [1]	H514 XXXX
HMC514LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL3 [2]	H514 XXXX

[1] Max peak reflow temperature of 235 °C
[2] Max peak reflow temperature of 260 °C
[3] 4-Digit lot number XXXX

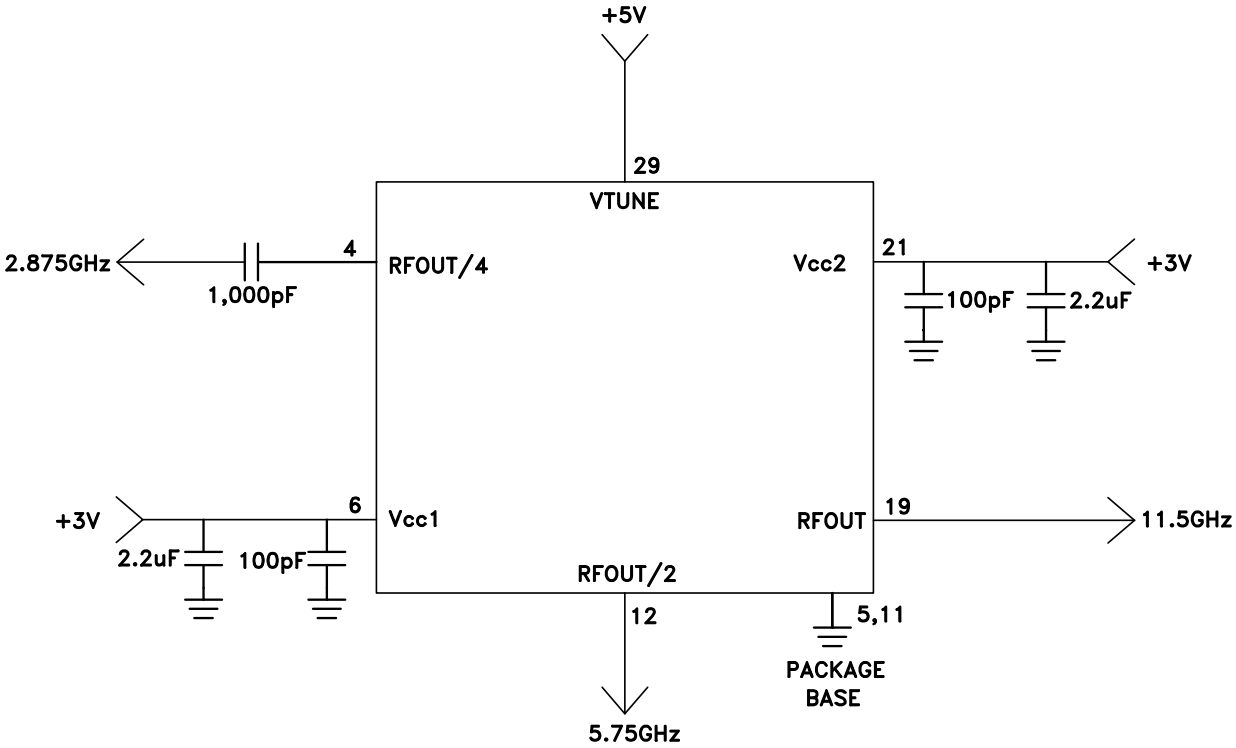
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 3, 7 - 10, 13 - 18, 20, 22 - 28, 30 - 32	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
4	RFOUT/4	Divide-by-4 Output.	
6	VCC1	Supply Voltage for prescaler. If prescaler is not required, this pin may be left open to conserve 40 mA of current.	

Pin Descriptions

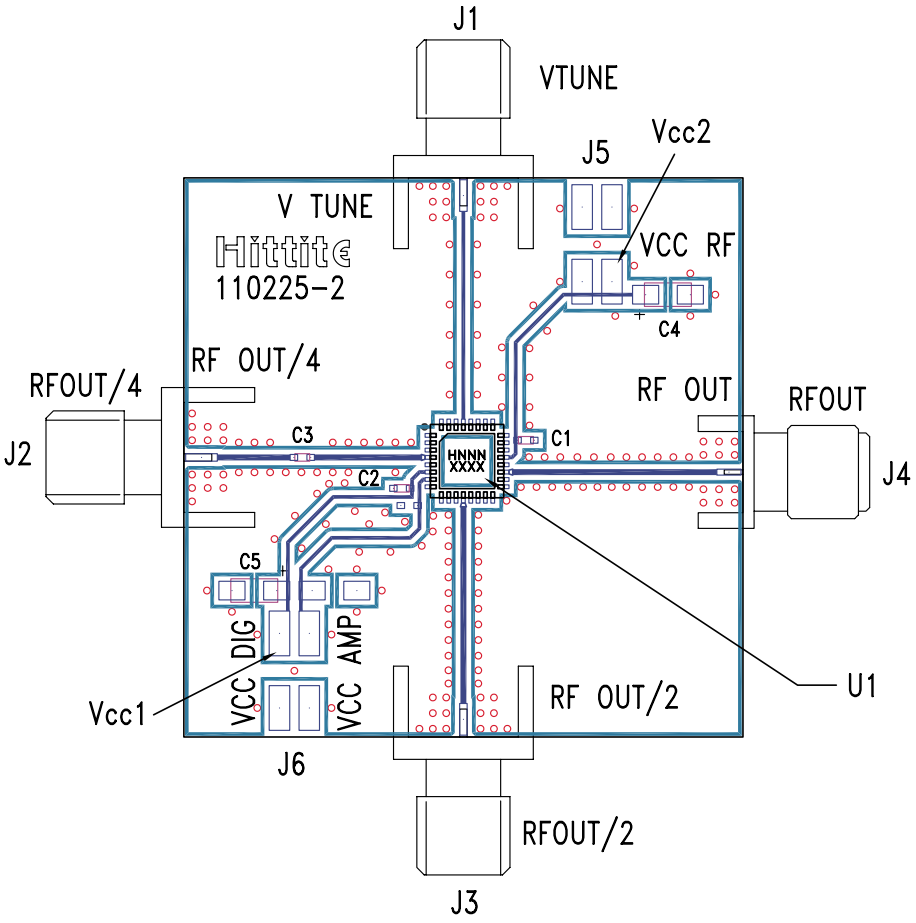
Pin Number	Function	Description	Interface Schematic
12	RFOUT/2	Half frequency output (AC coupled).	
19	RF OUT	RF output (AC coupled).	
21	VCC2	Supply Voltage, +3V	
29	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	
5, 11, Paddle	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	

Typical Application Circuit



For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824
Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com
Application Support: Phone: 978-250-3343 or apps@hittite.com

Evaluation PCB



List of Materials for Evaluation PCB 110227 [1]

Item	Description
J1 - J4	PCB Mount SMA RF Connector
J5 - J6	2 mm DC Header
C1 - C2	100 pF Capacitor, 0402 Pkg.
C3	1,000 pF Capacitor, 0402 Pkg.
C4 - C5	2.2 µF Tantalum Capacitor
U1	HMC514LP5 / HMC514LP5E VCO
PCB [2]	110225 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

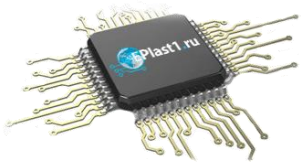
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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
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- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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